**Vishay Siliconix** 

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# N-Channel 60 V (D-S) MOSFET



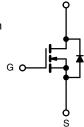
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	60					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0022					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 7.5 V	0.0024					
Q <sub>g</sub> typ. (nC)	128					
I <sub>D</sub> (A)	120 <sup>d</sup>					
Configuration	Single					

### **FEATURES**

- TrenchFET<sup>®</sup> power MOSFET
- Maximum 175 °C junction temperature
- Q<sub>gd</sub>/Q<sub>gs</sub> ratio < 0.25
- Operable with logic-level gate drive
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Power supply
  Secondary synchronous rectification
- DC/DC converter
- Power tools
- Motor drive switch
- DC/AC inverter
- Battery management



N-Channel MOSFET

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ORDERING INFORMATION				
Package	TO-263			
Lead (Pb)-free and halogen-free	SUM50020E-GE3			

ABSOLUTE MAXIMUM RATINGS (				-	
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	60	v	
Gate-source voltage	V <sub>GS</sub>	± 20	V		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		120 <sup>d</sup>		
	T <sub>C</sub> = 70 °C	– I <sub>D</sub> –	120 <sup>d</sup>	^	
Pulsed drain current (t = 100 µs)	I <sub>DM</sub>	300	- A		
Avalanche current	L = 0.1 mH	I <sub>AS</sub>	75		
Single avalanche energy <sup>a</sup>	L = 0.1 MH	E <sub>AS</sub>	281	mJ	
Martin and Alexandration 2	T <sub>C</sub> = 25 °C	Р	375 <sup>b</sup>	w	
Maximum power dissipation <sup>a</sup>	T <sub>C</sub> = 125 °C	- P <sub>D</sub> -	125 <sup>b</sup>	vv	
Operating junction and storage temperature ran	ige	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-ambient (PCB mount) <sup>c</sup>	R <sub>thJA</sub>	40	°C/W		
Junction-to-case (drain)	R <sub>thJC</sub>	0.4	0/10		

#### Notes

a. Duty cycle  $\leq$  1 %

b. See SOA curve for voltage derating

c. When mounted on 1" square PCB (FR4 material)

d. Package limited

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Document Number: 75403

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SUM50020E

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	•						
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A	60	-	-	V	
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},\ I_D=250\ \mu A$	2	-	4		
Gate-body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ± 20 V	-	-	± 250	nA	
Zero gate voltage drain current		$V_{DS} = 60 V, V_{GS} = 0 V$	-	-	1		
	I <sub>DSS</sub>	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	150	μA	
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	5	mA	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq$ 10 V, $V_{GS}$ = 10 V	120	-	-	А	
Drain-source on-state resistance <sup>a</sup>	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	-	0.0018	0.0022	0	
	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.0020	0.0024	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	-	145	-	S	
Dynamic <sup>b</sup>	•		•				
Input capacitance	C <sub>iss</sub>		-	11 150	-	pF	
Output capacitance	Coss	$V_{GS} = 0 V, V_{DS} = 30 V, f = 1 MHz$	-	4255	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	420	-		
Total gate charge <sup>c</sup>	Qg		-	128	-		
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	44	-	nC	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>		-	9	-		
Gate resistance	Rg	f = 1 MHz	0.32	1.6	3.2	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>		-	18	36		
Rise time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = 30 V, $R_L$ = 5 $\Omega$	-	20	40		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A},  V_{\text{GEN}} = 10  \text{V},  \text{R}_\text{g} = 1  \Omega$	-	55	100	- ns	
Fall time <sup>c</sup>	t <sub>f</sub>		-	23	35		
Drain-Source Body Diode Ratings a	nd Characteris	stics <sup>b</sup> (T <sub>C</sub> = 25 °C)	•		·		
Pulsed current (t = 100 $\mu$ s)	I <sub>SM</sub>		-	-	300	А	
Forward voltage <sup>a</sup>	V <sub>SD</sub>	$I_F = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.8	1.5	V	
Reverse recovery time	t <sub>rr</sub>		-	120	180	ns	
Peak reverse recovery charge	I <sub>RM(REC)</sub>	I <sub>F</sub> = 39 A, di/dt = 100 A/μs	-	5.5	11	А	
Reverse recovery charge	Q <sub>rr</sub>		-	0.320	0.480	μC	

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

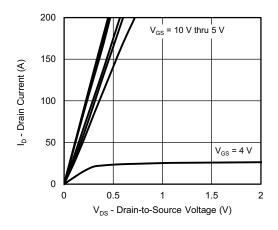
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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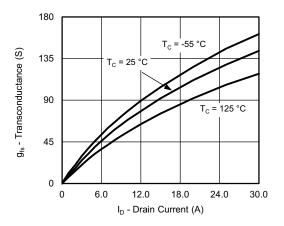


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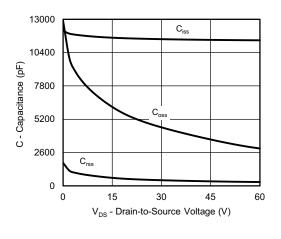
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



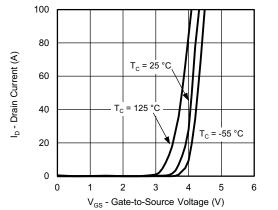
**Output Characteristics** 



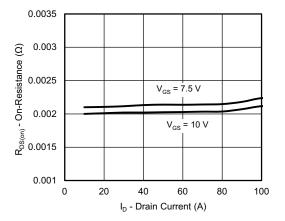
Transconductance

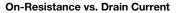


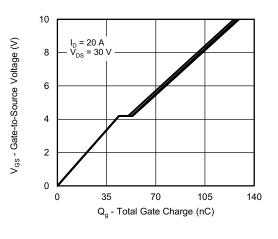
#### Capacitance



**Transfer Characteristics** 







**Gate Charge** 

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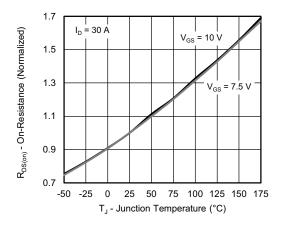
Document Number: 75403

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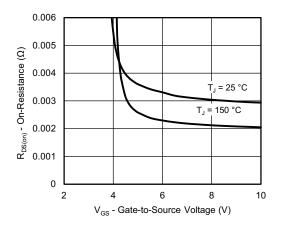


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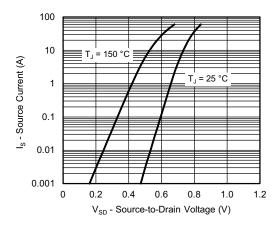
### TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



#### **On-Resistance vs. Junction Temperature**



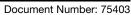
On-Resistance vs. Gate-to-Source Voltage



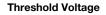
Source Drain Diode Forward Voltage

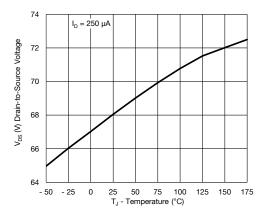
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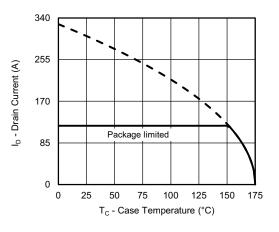


3.2 2.8 V<sub>GS(th)</sub> (V) 2.4  $I_D = 5 \text{ mA}$ 2.0  $I_D = 250 \ \mu A$ 1.6 1.2 -50 -25 0 25 50 75 100 125 150 175 T<sub>J</sub> - Temperature (°C)





Drain Source Breakdown vs. Junction Temperature

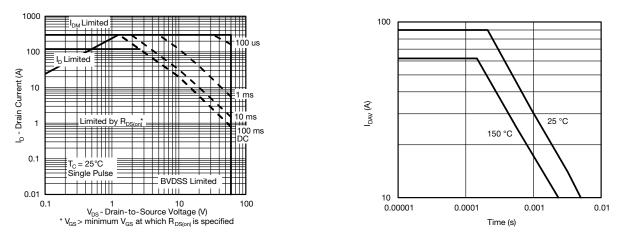


**Current De-rating** 



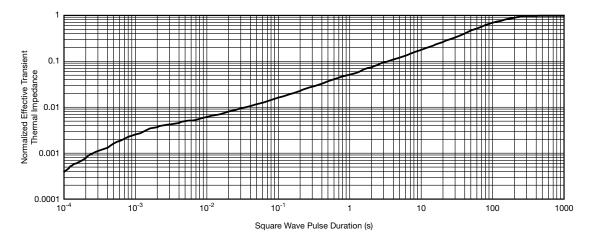
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## **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Safe Operating Area

Single Pulse Avalanche Current Capability vs. Time



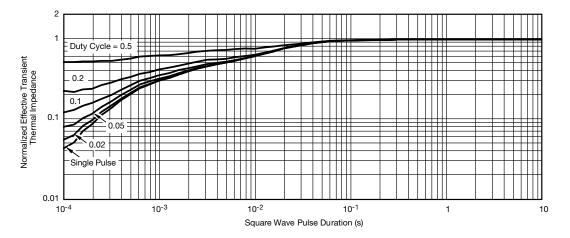
Normalized Thermal Transient Impedance, Junction-to-Ambient

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### THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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TO-263 (D<sup>2</sup>PAK): 3-LEAD









DETAIL A (ROTATED 90°)



		INC	HES	MILLIMETERS			
DIM.		MIN.	MAX.	MIN.	MAX.		
A		0.160	0.190	4.064	4.826		
b		0.020	0.039	0.508	0.990		
	b1	0.020	0.035	0.508	0.889		
	b2	0.045	0.055	1.143	1.397		
с*	Thin lead	0.013	0.018	0.330	0.457		
C	Thick lead	0.023	0.028	0.584	0.711		
c1	Thin lead	0.013	0.017	0.330	0.431		
CI	Thick lead	0.023	0.027	0.584	0.685		
	c2	0.045	0.055	1.143	1.397		
	D	0.340	0.380	8.636	9.652		
	D1	0.220	0.240	5.588	6.096		
D2		0.038	0.042	0.965	1.067		
D3		0.045	0.055	1.143	1.397		
D4		0.044	0.052	1.118	1.321		
	E	0.380	0.410	9.652	10.414		
	E1	0.245	-	6.223	-		
	E2	0.355	0.375	9.017	9.525		
	E3	0.072	0.078	1.829	1.981		
	е	0.100	0.100 BSC 2.54 BSC		0.100 BSC 2.54 BS		BSC
	К	0.045	0.055	1.143	1.397		
L		0.575	0.625	14.605	15.875		
	L1	0.090	0.110	2.286	2.794		
L2		0.040	0.055	1.016	1.397		
	L3	0.050	0.070	1.270	1.778		
	L4	0.010 BSC		0.254 BSC			
	М	-	0.002	-	0.050		
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843							

#### Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 % of L1 can fall above seating plane by
- max. 8 mils.3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB.
  - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



### **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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